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In re Application of:

Venkateshwaran Vaiyapuri

Serial No.: 10/082,392

Filed: February 25, 2002

For: DUAL LOC SEMICONDUCTOR
ASSEMBLY EMPLOYING FLOATING
LEAD FINGER STRUCTURE

Examiner: Unknown

Group Art Unit: 2811

Attorney Docket No.: 4369.1US (99-1230.1)

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PRELIMINARY AMENDMENT

Box Non-Fee Amendment
Commissioner for Patents
Washington, D.C. 20231

Sir:

Prior to examination of the above-referenced patent application on the merits, entry of the amendments as set forth herein is respectfully solicited.